













LM95071-Q1

JAJSGR8-DECEMBER 2018

# LM95071-Q1 SPI/MICROWIRE 13ビット+符号温度センサ

# 1 特長

- 車載アプリケーション用にAEC-Q100認定済みデバイス温度グレード0: -40°C~+150°C、T<sub>Δ</sub>
- 小型のSOT-23パッケージによる省スペース
- シャットダウン・モードで温度読み取り時以外の 電力を削減
- -40℃~+150℃の温度範囲の全体で動作
- SPIおよびMICROWIREバス・インターフェイス
- 主な仕様
  - 電源電圧: 2.4V~5.5V
  - 消費電流
    - 動作時:280µA(標準値)
    - シャットダウン時:6µA(標準値)
  - 温度精度
    - 0°C~70°C:±1°C(最大値)
    - -40°C~150°C:±2°C(最大値)
  - 温度分解能:0.03125°C

# 2 アプリケーション

- 車載用
- システムの熱管理
- 携帯用電子機器
- パーソナル・コンピュータ
- ディスク・ドライブ
- オフィス用電子機器
- 電子機器の試験装置

## 3 概要

LM95071-Q1は低消費電力、高分解能のデジタル温度 センサであり、SPIおよびMICROWIRE互換のインター フェイスが搭載され、5ピンのSOT-23パッケージで供給されます。ホストは随時LM95071-Q1を照会して、温度を読み取ることができます。動作電流が小さいため、低消費電力が重要なシステムに適しています。

LM95071-Q1は、13ビット+符号の温度分解能(0.03125° C/LSB)を持ち、-40°C~+150°Cの温度範囲で動作します。

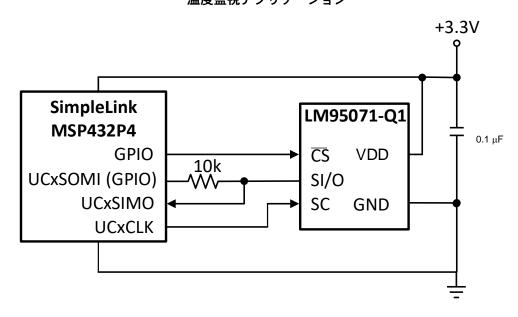
LM95071-Q1は2.4V~5.5Vの電源電圧範囲で動作し、変換速度が高く、消費電流が小さく、単純なSPIインターフェイスを搭載しているため、広範なアプリケーションに理想的です。

## 製品情報(1)

型番	パッケージ	本体サイズ(公称)
LM95071-Q1	SOT-23 (5)	2.90mm×1.60mm

(1) 提供されているすべてのパッケージについては、データシートの末 尾にある注文情報を参照してください。

# 温度監視アプリケーション





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# 4 改訂履歴

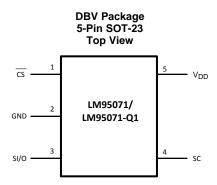
資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

日付	バージョン	注
2018年12月	*	初版。車載用デバイスをSNIS137から単独のデータシートに移動、AEC-Q100認定レベルをデータシートに追加、データシートのレイアウトを最新のSDSフォーマットに更新、先頭ページのキー・グラフィックを変更、温度からデジタルへのコンバータ特性の表の注記を変換間隔が明確になるよう変更、「熱特性」表を「熱に関する情報」表に置き換えて熱抵抗の値を更新



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# 5 Pin Configuration and Functions



#### **Pin Function**

NO. NAME		DESCRIPTION	
		DESCRIPTION	
1 <del>CS</del>		Chip Select input. This pin receives an active-low signal from the controller to select the device.	
2 GND		Ground. This is the power and signal ground return.	
3	SI/O	Serial Input/Output. This serial, bidirectional, data bus pin transmits and receives signals to and from the controller. Schmitt trigger input in the input mode.	
4	SC	Serial bus clock. This serial clock signal comes from the controller. Schmitt trigger input.	
5	$V_{DD}$	Positive Supply Voltage. Supply a DC voltage from 2.4V to 5.5V to this pin and bypass with a 0.1-µF ceramic capacitor to ground.	

# 6 Specifications

# 6.1 Absolute Maximum Ratings (1)(2)(3)

	MIN	MAX	UNIT
Supply voltage	-0.3	6	V
Voltage at any pin	-0.3	$V_{DD} + 0.3$	V
Input current at any pin (4)		5	mA
Storage temperature, T <sub>stg</sub>	-65	150	°C

- (1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. DC and AC electrical specifications do not apply when operating the device beyond its rated operating conditions.
- (2) Soldering process must comply with Reflow Temperature Profile specifications. Refer to http://www.ti.com/packaging.
- (3) Reflow temperature profiles are different for lead-free and non-lead-free packages.
- (4) When the input voltage (V<sub>I</sub>) at any pin exceeds the power supplies (V<sub>I</sub> < GND or V<sub>I</sub> > V<sub>DD</sub>) the current at that pin should be limited to 5 mA.

# 6.2 ESD Ratings

			VALUE	UNIT
V	Electrostatic discharge  HBM ESD Classification Level 2	Human-body model (HBM), per AEC Q100-002 <sup>(1)</sup> HBM ESD Classification Level 2	±2000	V
V <sub>(ESD)</sub>		Charged-device model (CDM), per AEC Q100-011 CDM ESD Classification Level C2	±200	V

(1) AEC Q100-002 indicates that HBM stressing shall be in accordance with the ANSI/ESDA/JEDEC JS-001 specification.



# 6.3 Recommended Operating Ratings

	MIN	MAX	UNIT
Specified temperature <sup>(1)</sup> , T <sub>MIN</sub> to T <sub>MAX</sub>	-40	150	°C
Supply voltage (V <sub>DD</sub> )	2.4	5.5	V

(1) The life expectancy of the of the LM95071-Q1 will be reduced when operating at elevated temperatures. of the LM95071-Q1 θ<sub>JA</sub> (thermal resistance, junction-to-ambient) when attached to a printed-circuit board with 2-oz. foil is summarized in the table below.

#### 6.4 Thermal Information

		LM95071-Q1	
	THERMAL METRIC <sup>(1)</sup>	DBV (SOT-23)	UNIT
		5 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	167.2	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	118.8	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	30.7	°C/W
ΨЈТ	Junction-to-top characterization parameter	14.4	°C/W
ΨЈВ	Junction-to-board characterization parameter	30.1	°C/W
R <sub>0</sub> JC(bot)	Junction-to-case (bottom) thermal resistance	n/a	°C/W

For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

## 6.5 Temperature-to-Digital Converter Characteristics

Unless otherwise noted, these specifications apply for  $V_{DD} = 3.3 \text{ V}$ . All limits  $T_A = T_J = +25^{\circ}\text{C}$ , unless otherwise noted.

PARAMETER	TES	r CONDITIONS	MIN <sup>(1)</sup>	TYP <sup>(2)</sup>	MAX <sup>(1)</sup>	UNIT
Temperature error <sup>(3)</sup>	$V_{DD} = 3.0V \text{ to } 3.6V; T_A = 0^{\circ}\text{C to}$	$V_{DD} = 3.0V \text{ to } 3.6V; T_A = 0^{\circ}\text{C to } +70^{\circ}\text{C}, T_A = T_J = T_{MIN} \text{ to } T_{MAX}$			±1.0	°C
remperature error	$V_{DD} = 3.0V \text{ to } 3.6V; T_A = -40^{\circ}C$	C to +150°C, $T_A = T_J = T_{MIN}$ to $T_{MAX}$			±2.0	°C
Line regulation	$V_{DD} = 3.6V \text{ to } 5.5V; T_A = 0^{\circ}\text{C to}$	o +70°C			+0.3	°C //
Line regulation	V <sub>DD</sub> = 3.0V to 2.4V; T <sub>A</sub> = 0°C to +70°C				-0.6	°C/V
Resolution				14 0.03125		Bits °C
Temperature	See <sup>(4)</sup>	$T_A = T_J = +25^{\circ}C$		130		ms
conversion time		$T_A = T_J = T_{MIN}$ to $T_{MAX}$			228	
	On a setting a section of the setting	$T_A = T_J = +25$ °C		280		
	Operating, serial bus inactive	$T_A = T_J = T_{MIN}$ to $T_{MAX}$			520	μΑ
Quiescent current	Chutdour	$T_A = T_J = +25^{\circ}C$		6		μА
	Shutdown	$T_A = T_J = T_{MIN}$ to $T_{MAX}$			28	

- (1) Limits are guaranteed to TI's AOQL (Average Outgoing Quality Level).
- (2) Typicals are at  $T_A = 25$ °C and represent most likely parametric norm.
- (3) The of the LM95071-Q1 will operate properly over the  $V_{DD}$  supply voltage range of 2.4V to 5.5V.
- (4) Following a power on reset, the user must allow at least 228 ms before making the first read transaction to ensure a first valid temperature read. After the first read, in order to ensure an accurate temperature result, the time interval between any two consecutive temperature reads must be greater than the maximum conversion time of 228 ms.

#### 6.6 Logic Electrical Characteristics - Digital DC Characteristics

Unless otherwise noted, these specifications apply for  $V_{DD} = 2.4 \text{ V}$  to 5.5  $V^{(1)}$ .

PARAMETER TEST CONDITIONS		MIN <sup>(2)</sup>	TYP <sup>(3)</sup> MAX <sup>(2)</sup>	UNIT
V <sub>IN(1)</sub> Logical "1" Input Voltage	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	0.7 × V <sub>DD</sub>	V <sub>DD</sub> + 0.3	V
V <sub>IN(0)</sub> Logical "0" Input Voltage	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	-0.3	$0.3 \times V_{DD}$	V

- (1) The of the LM95071-Q1 will operate properly over the  $V_{DD}$  supply voltage range of 2.4V to 5.5V.
- (2) Limits are guaranteed to TI's AOQL (Average Outgoing Quality Level).
- (3) Typicals are at  $T_A = 25$ °C and represent most likely parametric norm.

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# Logic Electrical Characteristics - Digital DC Characteristics (continued)

Unless otherwise noted, these specifications apply for  $V_{DD}$  = 2.4 V to 5.5  $V^{(1)}$ .

	PARAMETER	TEST (	CONDITIONS	MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
	Input Hysteresis	V <sub>DD</sub> = 3 V to 3.6 V	$T_A = T_J = +25$ °C		0.4		V
	Voltage	V <sub>DD</sub> = 3 V 10 3.6 V	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	0.33			V
	Logical "1" Input	$V_{IN} = V_{DD}$	$T_A = T_J = +25$ °C		0.005		
I <sub>IN(1)</sub>	Current	VIN = VDD	$T_A = T_J = T_{MIN}$ to $T_{MAX}$			3	μA
	Logical "0" Input	$V_{IN} = 0 V$	$T_A = T_J = +25$ °C		-0.005		
I <sub>IN(0)</sub>	Current	VIN = 0 V	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	-3			μA
C <sub>IN</sub>	All Digital Inputs	$T_A = T_J = +25^{\circ}C$			20		pF
$V_{OH}$	High Level Output Voltage	$I_{OH} = -400 \mu A, T_A = T_J =$	T <sub>MIN</sub> to T <sub>MAX</sub>	2.25			V
V <sub>OL</sub>	Low Level Output Voltage	$I_{OL} = +1.6 \text{ mA}, T_A = T_J = 0.00$	T <sub>MIN</sub> to T <sub>MAX</sub>			0.4	V
I <sub>O_TRI</sub> -	TRI-STATE <sup>®</sup> Output Leakage Current	$\begin{aligned} V_O &= GND \\ V_O &= V_{DD}, \ T_A = T_J = T_{MIN} \end{aligned}$	to T <sub>MAX</sub>	-1		+1	μΑ

# 6.7 Logic Electrical Characteristics - Serial Bus Digital Switching Characteristics

Unless otherwise noted, these specifications apply for  $V_{DD}$  = 2.4 V to 5.5  $V^{(1)}$ ;  $C_L$  (load capacitance) on output lines = 100 pF unless otherwise specified.

			MIN <sup>(2)</sup>	TYP <sup>(3)</sup>	MAX <sup>(2)</sup>	UNIT
	SC (Clock) Period	$T_A = T_J = T_{MIN}$ to $T_{MAX}$			0.16	μs
t <sub>1</sub>	SC (Clock) Period	$T_A = T_J = +25$ °C			DC	
t <sub>2</sub>	CS Low to SC (Clock) High Set-Up Time	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	100			ns
t <sub>3</sub>	CS Low to Data Out (SO) Delay	$T_A = T_J = T_{MIN}$ to $T_{MAX}$			70	ns
t <sub>4</sub>	SC (Clock) Low to Data Out (SO) Delay	$T_A = T_J = T_{MIN}$ to $T_{MAX}$			70	ns
t <sub>5</sub>	CS High to Data Out (SO) TRI-STATE	$T_A = T_J = T_{MIN}$ to $T_{MAX}$			200	ns
t <sub>6</sub>	SC (Clock) High to Data In (SI) Hold Time	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	50			ns
t <sub>7</sub>	Data In (SI) Set-Up Time to SC (Clock) High	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	30			ns
t <sub>8</sub>	SC (Clock) High to CS High Hold Time	$T_A = T_J = T_{MIN}$ to $T_{MAX}$	50			ns

- The of the LM95071-Q1 will operate properly over the V<sub>DD</sub> supply voltage range of 2.4V to 5.5V.
   Limits are guaranteed to Tl's AOQL (Average Outgoing Quality Level).
   Typicals are at T<sub>A</sub> = 25°C and represent most likely parametric norm.

#### 6.8 Timing Diagrams

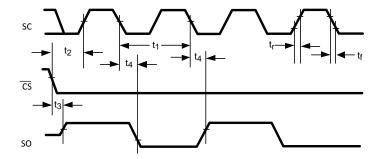


Figure 1. Data Output Timing Diagram

# **Timing Diagrams (continued)**

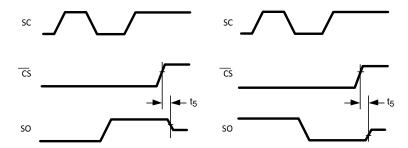


Figure 2. TRI-STATE Data Output Timing Diagram

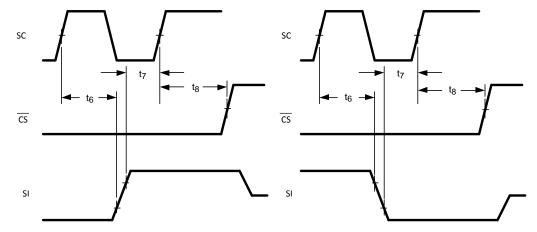
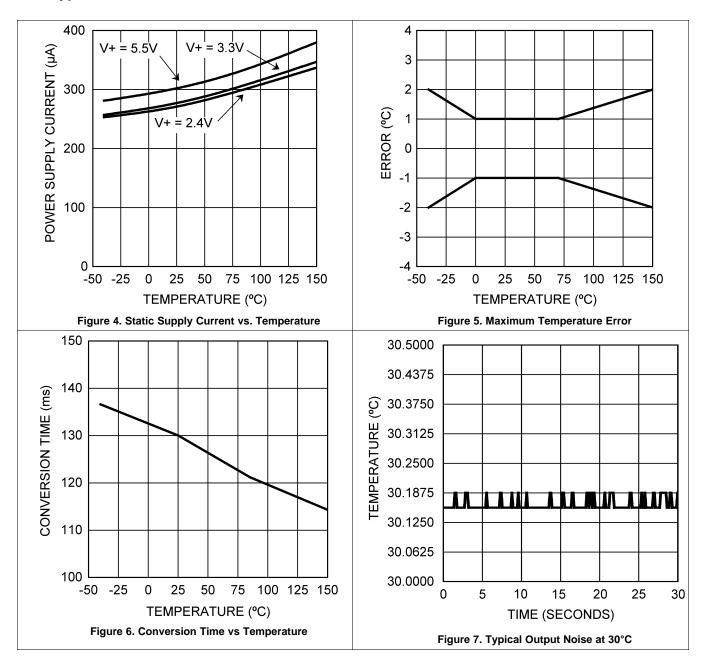


Figure 3. Data Input Timing Diagram



# 6.9 Typical Characteristics



# 7 Parameter Measurement Information

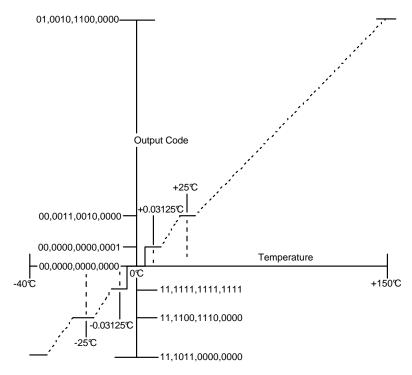


Figure 8. Temperature-to-Digital Transfer Function (Non-Linear Scale for Clarity)

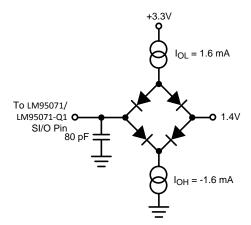


Figure 9. TRI-STATE Test Circuit

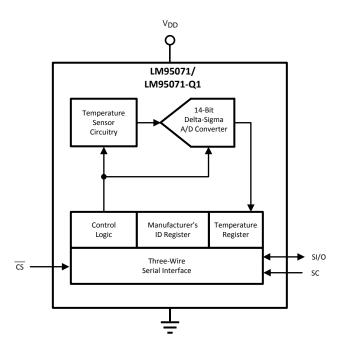
# 8 Detailed Description

#### 8.1 Overview

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The LM95071-Q1 temperature sensor incorporates a temperature sensor and 13-bit-plus-sign  $\Delta\Sigma$  ADC (Delta-Sigma Analog-to-Digital Converter). Compatibility of the LM95071-Q1's three-wire serial interface with SPI and MICROWIRE allows simple communications with common microcontrollers and processors. Shutdown mode can be used to optimize current drain for different applications. A Manufacturer/Device ID register identifies the LM95071-Q1 as a Texas Instruments product.

## 8.2 Functional Block Diagram



## 8.3 Feature Description

#### 8.3.1 Power Up and Power Down

The LM95071-Q1 always powers up in a known state and in the continuous conversion mode. Immediately after power up, the LM95071-Q1 will output an erroneous code until the first temperature conversion has completed.

When the supply voltage is less than about 1.6V (typical), the LM95071-Q1 is considered powered down. As the supply voltage rises above the nominal 1.6-V power up threshold, the internal registers are reset to the power up default state described above.

#### 8.3.2 Temperature Data Format

Temperature data is represented by a 14-bit, two's complement word with an LSB (Least Significant Bit) equal to 0.03125°C:

Table 1. Digital Output for Temperature Data

Tomporeture	Digital Output								
Temperature	Binary	Hex							
+150°C	0100 1011 0000 0011	4B03							
+125°C	0011 1110 1000 0011	3E83							
+25°C	0000 1100 1000 0011	0C83							
+0.03125°C	0000 0000 0000 0111	0007							
0°C	0000 0000 0000 0011	0003							

# Table 1. Digital Output for Temperature Data (continued)

Tamananatura	Digital Output							
Temperature	Binary	Hex						
-0.03125°C	1111 1111 1111 1111	FFFF						
-25°C	1111 0011 1000 0011	F383						
-40°C	1110 1100 0000 0011	EC03						

The first data byte is the most significant byte with most significant bit first, permitting only as much data as necessary to be read to determine temperature condition. For instance, if the first four bits of the temperature data indicate an overtemperature condition, the host processor could immediately take action to remedy the excessive temperatures.

#### 8.3.3 Tight Accuracy, Fine Resolution and Low Noise

The LM95071-Q1 is well suited for applications that require tight temperature measurement accuracy. In many applications, from process control to HVAC, the low temperature error can mean better system performance and, by eliminating a system calibration step, lower production cost.

With fine digital resolution, the LM95071-Q1 senses and reports very small changes in its temperature, making it ideal for applications where temperature sensitivity is important. For example, the LM95071-Q1 enables the system to quickly identify the direction of temperature change, allowing the processor to take compensating action before the system reaches a critical temperature.

The LM95071-Q1 has very low output noise (see Figure 7 in the *Typical Characteristics* section), which makes it ideal for applications where stable thermal compensation is a priority. For example, in a temperature-compensated oscillator application, the very small deviation in successive temperature readings translates to a stable frequency output from the oscillator.

#### 8.4 Device Functional Modes

#### 8.4.1 Shutdown Mode/Manufacturer ID

The master controller may enable the shutdown mode for the purpose of reducing power consumption or for reading the Manufacturer/Device ID information. The shutdown mode is enabled by writing XX FF hex to the LM95071-Q1 as shown in Figure 13c. The serial bus is still active when the LM95071-Q1 is in shutdown. When in shutdown mode the LM95071-Q1 always will output 1000 0000 0000 1111. This is the Manufacturer/Device ID information. The first 5-bits of the field (1000 0XXX) are reserved for the manufacturer ID.

#### 8.5 Programming

#### 8.5.1 Serial Bus Interface

The LM95071-Q1 operates as a slave and is compatible with SPI or MICROWIRE bus specifications. Data is clocked out on the falling edge of the serial clock (SC), while data is clocked in on the rising edge of SC. A complete communication is framed by falling and rising chip select (CS) signal. The CS signal should be held high for at least one clock cycle (160 ns minimum) between communications. The transmit-only communication (register read) consists of 16 clock cycles. A complete transmit/receive communication will consist of 32 serial clocks (see Serial Bus Timing Diagrams). The first 16 clocks comprise the transmit phase of communication, while the second 16 clocks are the receive phase.

When  $\overline{CS}$  is high SI/O will be in TRI-STATE. Communication should be initiated by taking chip select ( $\overline{CS}$ ) low. This should not be done when SC is changing from a low to high state. Once  $\overline{CS}$  is low the serial I/O pin (SI/O) will transmit the first bit of data. The master can then read this bit with the rising edge of SC. The remainder of the data will be clocked out by the falling edge of SC.  $\overline{CS}$  can be taken high at any time during the transmit phase. If  $\overline{CS}$  is brought low in the middle of a conversion the LM95071-Q1 will complete the conversion and the output shift register will be updated after  $\overline{CS}$  is brought back high.

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# **Programming (continued)**

The receive phase of a communication starts after 16 SC periods.  $\overline{\text{CS}}$  can remain low for 32 SC cycles. The LM95071/LM95071-Q1 will read the data available on the SI/O line on the rising edge of the serial clock. Input data is to an 8-bit shift register. The part will detect the last eight bits shifted into the register. The receive phase can last up to 16 SC periods. All ones must be shifted in order to place the part into shutdown. All zeros must be shifted in order to place the LM95071-Q1 into continuous conversion mode. Only the following codes should be transmitted to the LM95071-Q1:

- 00 hex for continuous conversion
- FF hex for shutdown

Another code may place the part into a test mode. Test modes are used by Texas Instruments to thoroughly test the function of the LM95071-Q1 during production testing. Only eight bits have been defined above since only the last eight transmitted are detected by the LM95071-Q1, before CS is taken HIGH.

The following communication can be used to determine the Manufacturer's/Device ID and then immediately place the part into continuous conversion mode. With  $\overline{\text{CS}}$  continuously low:

- · Read 16 bits of temperature data
- Write 16 bits of data commanding shutdown
- Read 16 bits of Manufacture's/Device ID data
- Write 8 to 16 bits of data commanding Conversion Mode
- Take CS HIGH.

Note that 228 ms (max) will have to pass for a conversion to complete before the LM95071-Q1 actually transmits temperature data.

#### 8.5.2 Serial Bus Timing Diagrams

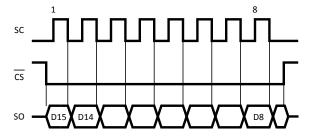


Figure 10. Reading Continuous Conversion - Single Eight-Bit Frame

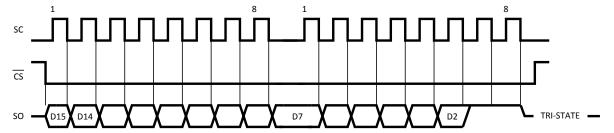


Figure 11. Reading Continuous Conversion - Two Eight-Bit Frames

## Programming (continued)

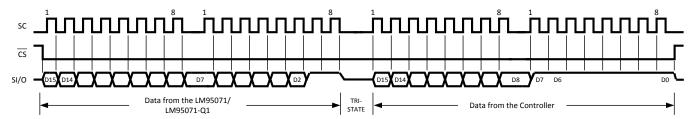


Figure 12. Writing Shutdown Mode

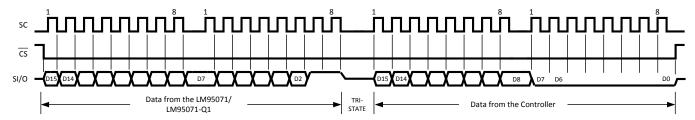


Figure 13. Writing Conversion Mode

## 8.6 Register Maps

#### 8.6.1 Internal Register Structure

The LM95071-Q1 has three registers: the temperature register, the configuration register and the Manufacturer/Device identification register. The temperature and Manufacturer/Device identification registers are read only. The configuration register is write only.

#### 8.6.1.1 Configuration Register

(Selects shutdown or continuous conversion modes):

#### Table 2. (Write Only):

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
X	X	X	Х	X	X	X	X	Shutdown							

D0-D15 set to XX FF hex enables shutdown mode.

D0-D15 set to XX 00 hex sets continuous-conversion mode.

Note: setting D0-D15 to any other values may place the LM95071-Q1 into a manufacturer's test mode, upon which the LM95071-Q1 will stop responding as described. These test modes are to be used for Texas Instruments production testing only. See Serial Bus Interface for a complete discussion.

#### 8.6.1.2 Temperature Register

#### Table 3. (Read Only):

D1:	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
MS	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit1	LSB	1	1



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D0-D1: Logic 1 will be output on SI/0.

D2–D15: Temperature Data. One LSB = 0.03125 °C. Two's complement format.

# 8.6.1.3 Manufacturer/Device ID Register

# Table 4. (Read Only):

D15	D14	D13	D12	D11	D10	D9	D8	D7	D6	D5	D4	D3	D2	D1	D0
1	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1

D0-D1: Logic 1 will be output on SI/0.

D2-D15: Manufacturer/Device ID Data. This register is accessed whenever the LM95071-Q1 is in shutdown mode.



# 9 デバイスおよびドキュメントのサポート

#### 9.1 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、ti.comのデバイス製品フォルダを開いてください。右上の「アラートを受け取る」をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取れます。変更の詳細については、修正されたドキュメントに含まれている改訂履歴をご覧ください。

# 9.2 コミュニティ・リソース

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

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設計サポート *TIの設計サポート* 役に立つE2Eフォーラムや、設計サポート・ツールをすばやく見つけることができます。技術サポート用の連絡先情報も参照できます。

#### 9.3 商標

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#### 9.4 静電気放電に関する注意事項



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#### 9.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

#### 10 メカニカル、パッケージ、および注文情報

以降のページには、メカニカル、パッケージ、および注文に関する情報が記載されています。この情報は、そのデバイスについて利用可能な最新のデータです。このデータは予告なく変更されることがあり、ドキュメントが改訂される場合もあります。本データシートのブラウザ版を使用されている場合は、画面左側の説明をご覧ください。



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#### PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LM95071QIMFX/NOPB	ACTIVE	SOT-23	DBV	5	3000	RoHS & Green	SN	Level-1-260C-UNLIM	-40 to 150	T18Q	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF LM95071-Q1:

# **PACKAGE OPTION ADDENDUM**

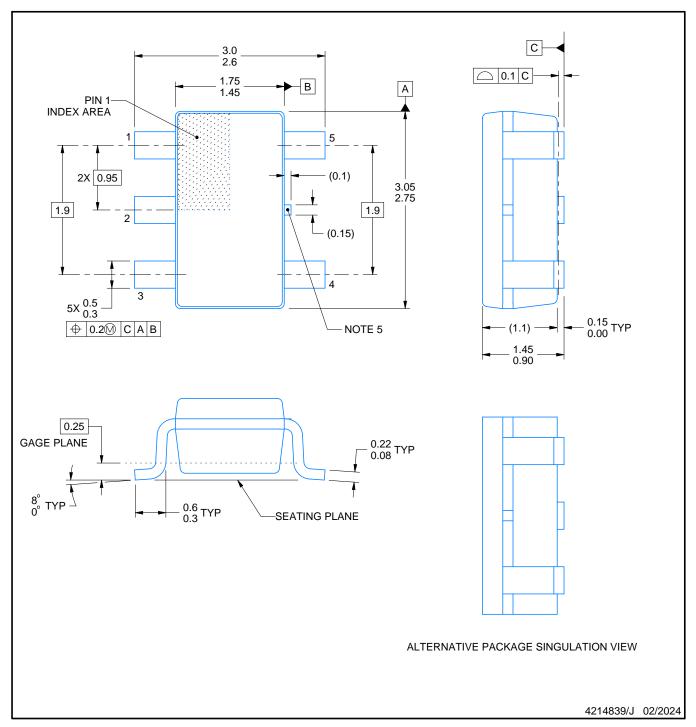
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NOTE: Qualified Version Definitions:

• Catalog - TI's standard catalog product



SMALL OUTLINE TRANSISTOR



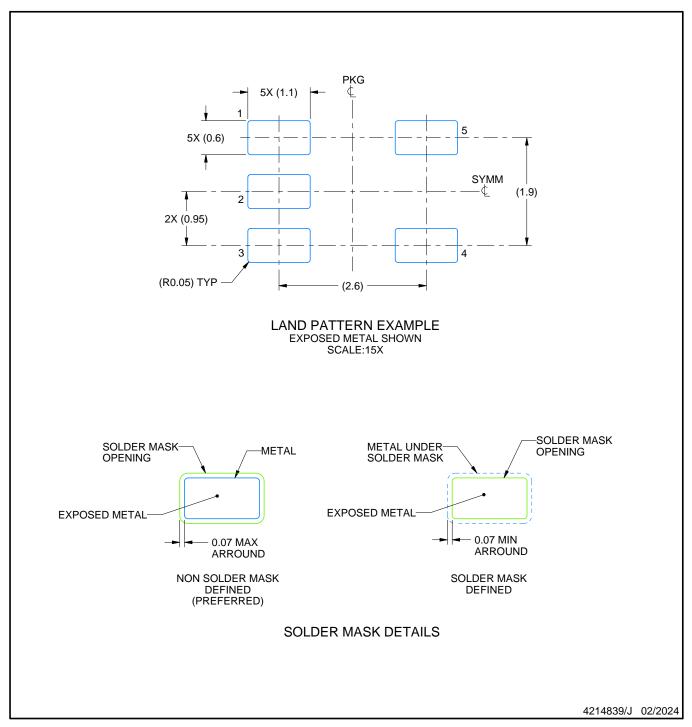
#### NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
  2. This drawing is subject to change without notice.
  3. Reference JEDEC MO-178.

- 4. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25 mm per side.
- 5. Support pin may differ or may not be present.



SMALL OUTLINE TRANSISTOR



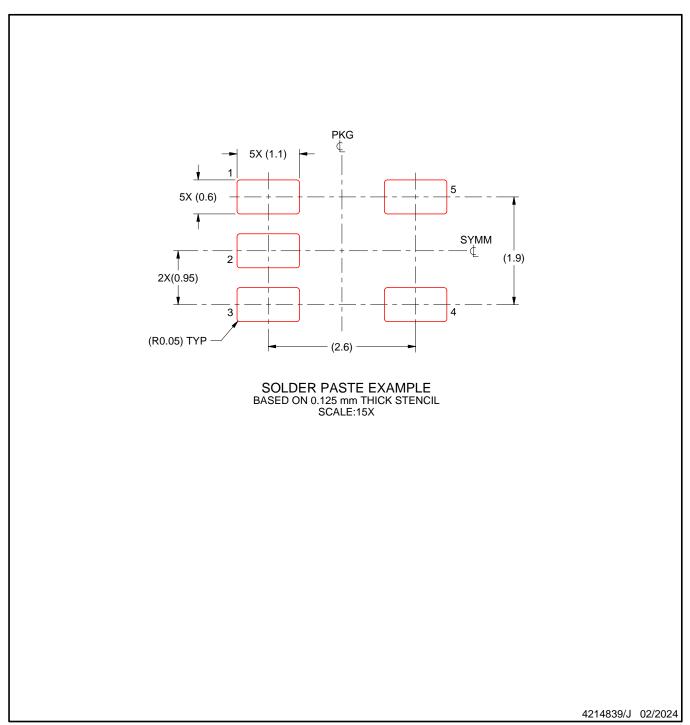
NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE TRANSISTOR



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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